

P-Channel 60-V (D-S) MOSFET

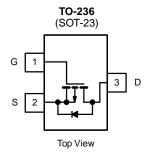
PRODUCT SUMMARY				
V _{DS} (V)	- 60			
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = - 10 V 0.04			
Q _g (Max.) (nC)	12			
Q _{gs} (nC)	3.8			
Q _{gd} (nC)	5.1			
Configuration	Single			

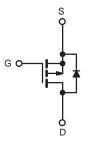
FEATURES

- · Isolated Package
- High Voltage Isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz



- Sink to Lead Creepage Distance = 4.8 mm
- P-Channel
- 175 °C Operating Temperature
- Dynamic dV/dt Rating
- · Low Thermal Resistance
- Lead (Pb)-free Available





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, ui	nless otherv	vise noted		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	- 60	V
Gate-Source Voltage			V_{GS}	± 20	V
Continuous Drain Current	in Current V_{GS} at - 10 V $\frac{T_C = 25 ^{\circ}\text{C}}{T_C = 100 ^{\circ}\text{C}}$ I_D $\frac{-5.2}{-3.8}$				
Continuous Dialii Curient	VGS at - 10 V	$T_C = 100 ^{\circ}C$	ıD	- 3.8	Α
Pulsed Drain Current ^a			I_{DM}	- 21	
Linear Derating Factor				0.18	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	120	mJ
Repetitive Avalanche Current ^a			I_{AR}	- 5.2	Α
Repetitive Avalanche Energy ^a			E _{AR}	2.7	mJ
Maximum Power Dissipation	T _C = 25 °C		P_{D}	27	W
Peak Diode Recovery dV/dtc			dV/dt	- 4.5	V/ns
Operating Junction and Storage Temperature Range		T_J,T_stg	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for '	10 s		300 ^d	
Mounting Torque	6-32 or M3 screw		lbf ⋅ in		
Wounting Forque				1.1	N⋅m

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. V_{DD} = 25 V, starting T_J = 25 °C, L = 5.0 mH, R_G = 25 Ω , I_{AS} = 5.3 A (see fig. 12). c. I_{SD} < 6.7 A, dI/dt < 90 A/µs, V_{DD} \leq V_{DS} , V_{DS} = 175 °C.

- d. 1.6 mm from case.



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R_{thJA}	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	5.5	C/VV	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = - 250 μA	- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = - 1 mA	-	- 0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 1.0	-	- 2.5	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
7 0		V _{DS} =	V _{DS} = - 60 V, V _{GS} = 0 V		-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 48	V _{GS} = 0 V, T _J = 150 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 3.2 A ^b	-	0.05	-	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	- 25 V, I _D = - 3.2 A ^b	1.6	-	-	S
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	270	-	- pF
Output Capacitance	C _{oss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ f = 1.0 MHz, see fig. 5		170	-	
Reverse Transfer Capacitance	C _{rss}	f = 1			31	-	
Drain to Sink Capacitance	С		f = 1.0 MHz	-	12	-	
Total Gate Charge	Qg			-	-	12	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$I_D = -4.7 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13 ^b	-	-	3.8	nC
Gate-Drain Charge	Q _{gd}		See fig. 6 dilla 16	-	-	5.1	
Turn-On Delay Time	t _{d(on)}			-	11	-	
Rise Time	t _r		$-30 \text{ V}, I_D = -4.7 \text{ A},$	-	63	-	
Turn-Off Delay Time	t _{d(off)}	$R_{G} =$	24 Ω R_D = 4.0 Ω, see fig. 10 ^b	-	9.6	-	ns
Fall Time	t _f	7	-	-	31	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact - 4.5 - 7.5		-	4.5	-	
Internal Source Inductance	L _S			-	— nH		
Drain-Source Body Diode Characteristic	s				•		,
Continuous Source-Drain Diode Current	I _S	showing the integral reverse p - n junction diode		-	-	- 5.2	А
Pulsed Diode Forward Current ^a	I _{SM}			- 21			
Body Diode Voltage	V_{SD}	T _J = 25 °C,	$I_S = -5.2 \text{ A}, V_{GS} = 0 \text{ V}^b$	-	-	- 5 .5	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C 1	= - 4.7 A, dl/dt = 100 A/µsb	-	80	160	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1J = 25 C, IF	τ. / Α, αι/αι = 100 Α/μS°	_	0.096	0.19	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn-	on is dor	ninated by	/ L _S and I	_D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

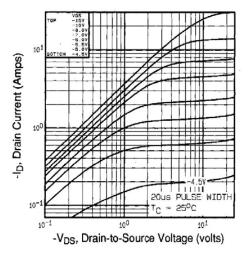


Fig. 1 - Typical Output Characteristics, T_C= 25 °C

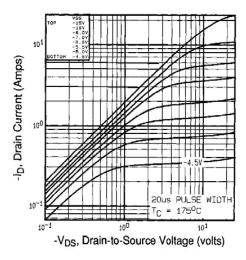


Fig. 2 - Typical Output Characteristics, T_C= 175 °C

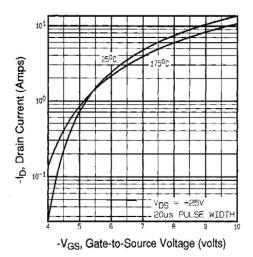


Fig. 3 - Typical Transfer Characteristics

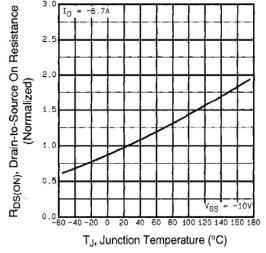


Fig. 4 - Normalized On-Resistance vs. Temperature



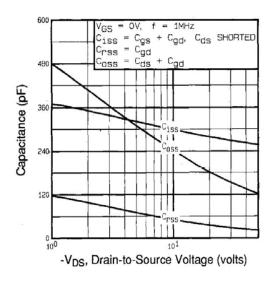


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

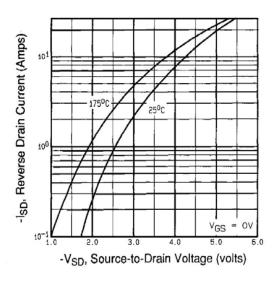


Fig. 7 - Typical Source-Drain Diode Forward Voltage

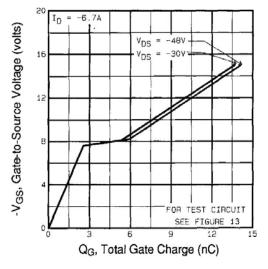


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

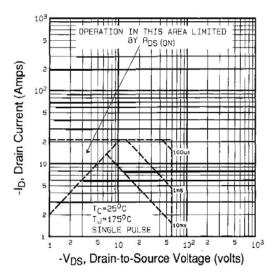


Fig. 8 - Maximum Safe Operating Area



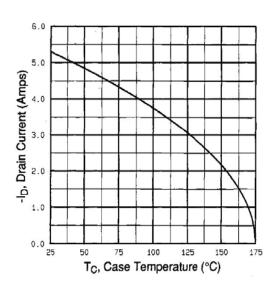


Fig. 9 - Maximum Drain Current vs. Case Temperature

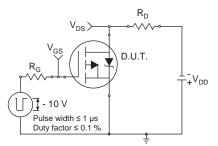


Fig. 10a - Switching Time Test Circuit

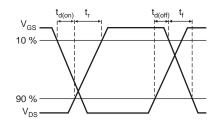


Fig. 10b - Switching Time Waveforms

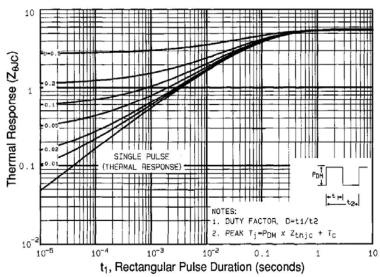


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

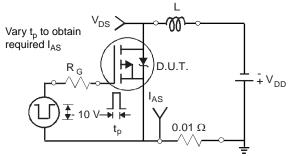


Fig. 12a - Unclamped Inductive Test Circuit

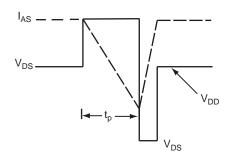


Fig. 12b - Unclamped Inductive Waveforms



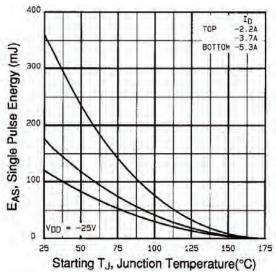


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

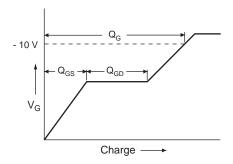


Fig. 13a - Basic Gate Charge Waveform

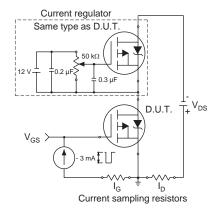
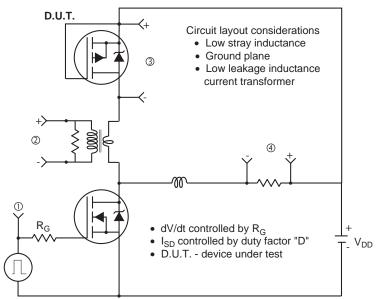


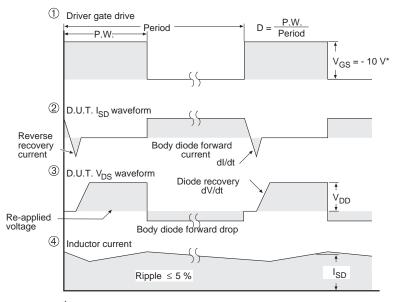
Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

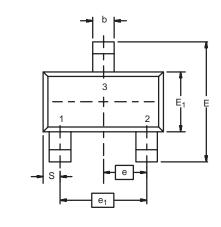


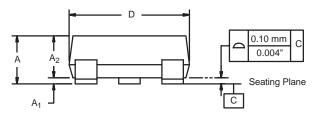
V_{GS} = -5 V for logic level and -3 V drive devices

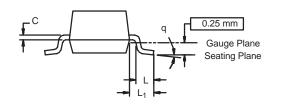
Fig. 14 - For P-Channel



SOT-23 (TO-236): 3-LEAD







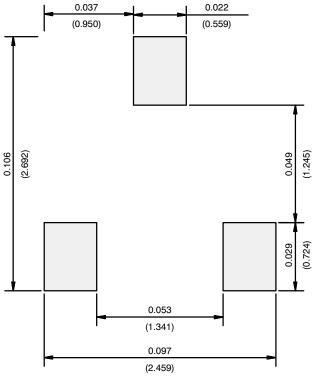
Dim	MILLIM	ETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	

DWG: 5479

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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